

# INTERNATIONAL STANDARD

# IEC 61076-4-108

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## Connectors for electronic equipment -

### Part 4-108:

**Printed board connectors with assessed quality –  
Detail specification for cable-to-board connectors,  
with a modular pitch of 25 mm and integrated  
shielding function, applicable for transverse  
packing density of 10 mm, having a basic grid  
of 2,5 mm in accordance with IEC 60917-1**

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## CONTENTS

FOREWORD.....	5
1 General data.....	8
1.1 Recommended method of mounting.....	8
1.1.1 Maximum number of contacts.....	9
1.2 Ratings and characteristics.....	11
1.3 Normative references.....	11
1.4 Marking.....	12
1.5 IEC type designation.....	13
1.6 Ordering information.....	13
2 Technical information.....	14
2.1 Definitions.....	14
2.1.1 Mechanical features.....	14
2.1.2 Contacts and terminations.....	14
2.1.3 Engagement sequence.....	14
2.1.4 Mechanical coding, locking.....	15
2.2 Surveys of styles and variants.....	15
2.2.1 Styles of connectors.....	15
2.2.2 Survey of termination variants.....	20
2.3 Information on application.....	21
2.3.1 Connector pairs.....	21
2.3.2 Fixed board connectors.....	22
2.3.3 Free cable connectors.....	23
2.3.4 Accessories.....	23
2.3.5 Shielding and grounding.....	24
2.3.6 Basic styles of the connections.....	25
2.4 Survey of contact arrangement.....	25
3 Dimensional information.....	26
3.1 General.....	26
3.2 Isometric view and common features.....	27
3.2.1 Common features.....	28
3.2.2 Reference system.....	28
3.2.3 Height dimensions.....	29
3.2.4 Width dimensions.....	30
3.2.5 Depth dimensions.....	31
3.3 Mating information.....	31
3.3.1 Engaging direction.....	31
3.3.2 Perpendicular to engaging direction.....	31
3.3.3 Inclination.....	31
3.4 Fixed board connectors.....	32
3.4.1 Dimensions of board connectors.....	32
3.4.2 Dimensions of male contacts.....	39

3.5	Free cable connectors .....	41
3.5.1	Dimensions of cable connectors .....	41
3.5.2	Dimensions of female contacts .....	45
3.6	Accessories .....	46
3.6.1	Coding devices .....	46
3.6.2	Shielding / ground contact .....	47
3.7	Mounting information for fixed board connectors .....	48
3.7.1	Hole pattern on backplane .....	48
3.7.2	Hole pattern on printed board (front) .....	49
3.8	Mounting information for free cable connectors .....	49
3.9	Gauges .....	50
3.9.1	Sizing and retention force gauges .....	50
3.9.2	Test gauge for shield / ground contact .....	50
4	Characteristics .....	51
4.1	Climatic categories .....	51
4.2	Electrical .....	51
4.2.1	Creepage and clearance distances .....	51
4.2.2	Voltage proof .....	51
4.2.3	Current carrying capacity .....	52
4.2.4	Initial contact resistance .....	52
4.2.5	Initial insulation resistance .....	52
4.3	Mechanical .....	53
4.3.1	Mechanical operation .....	53
4.3.2	Engaging and separating forces .....	53
4.3.3	Contact retention in insert .....	53
4.3.4	Static load, transverse .....	53
4.3.5	Withdrawal force with cable .....	53
4.3.6	Vibration (sinusoidal) .....	54
4.3.7	Shock .....	54
4.3.8	Polarizing method .....	54
4.3.9	Mechanical coding .....	54
4.3.10	Latching force in male connector body .....	55
4.3.11	Cable clamp resistance to cable rotation .....	55
4.3.12	Cable connector drop test .....	55
4.4	Electromagnetic compatibility (EMC) .....	55
4.4.1	Shielding effectiveness .....	55
5	Test schedule .....	56
5.1	General .....	56
5.1.1	Arrangement for contact resistance measurement .....	57
5.1.2	Arrangement for dynamic stress tests .....	57
5.1.3	Arrangement for testing static load, transverse .....	58
5.1.4	Arrangement for testing insulation resistance, voltage proof and polarization voltage .....	59
5.1.5	Arrangement for flammability test .....	59
5.2	Test schedule tables .....	60
5.2.1	Group P – Preliminary .....	60
5.2.2	Group AP – Dynamic / Climatic .....	61
5.2.3	Group BP – Mechanical endurance .....	64

5.2.4	Group CP – Moisture .....	65
5.2.5	Group DP – Electrical load .....	65
5.2.6	Group EP – Mechanical resistivity .....	66
5.2.7	Group FP – Chemical resistivity .....	67
5.2.8	Group GP – Connections .....	67
5.2.9	Group HP – Electromagnetic compatibility .....	67
6	Quality assessment procedures .....	67
6.1	Qualification approval testing .....	67
6.1.1	Method 1 .....	67
6.1.2	Method 2 .....	67
6.2	Quality conformance inspection .....	68
6.2.1	Lot-by-lot tests .....	68
6.2.2	Periodic tests .....	69
6.3	Delayed delivery, re-inspection .....	69

Annex A (informative) Shielding effectiveness

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

## CONNECTORS FOR ELECTRONIC EQUIPMENT –

**Part 4-108: Printed board connectors with assessed quality –  
Detail specification for cable-to-board connectors, with a modular pitch  
of 25 mm and integrated shielding function, applicable for transverse  
packing density of 15 mm, having a basic grid of 2,5 mm  
in accordance with IEC 60917-1**

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International Standard IEC 61076-4-108 has been prepared by subcommittee 48B: Connectors, of IEC technical committee 48: Electromechanical components and mechanical structures for electronic equipment.

The text of this standard is based on the following documents:

FDIS	Report on voting
48B/1122/FDIS	48B/1170/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

Future standards in this series will carry the new general title as cited above. Titles of existing standards in this series will be updated when a new edition is prepared.

The QC number that appears on the front cover of this publication is the specification number in the IEC Quality Assessment System for Electronic Components (IECQ).

This publication has been drafted in accordance with the ISO/IEC Directives, Part 3.

Annex A is for information only.

The committee has decided that the contents of this publication will remain unchanged until 2004. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

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